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**UTILITY
PATENT APPLICATION
TRANSMITTAL**

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Attorney Docket No.

35.C14946

First Named Inventor or Application Identifier

JUN KOIDE

Express Mail Label No.

APPLICATION ELEMENTS

See MPEP chapter 600 concerning utility patent application contents.

ADDRESS TO:Commissioner for Patents
Box Patent Application
Washington, DC 20231

1. ☐ Fee Transmittal Form
(Submit an original, and a duplicate for fee processing)
2. ☐ Applicant claims small entity status.
See 37 CFR 1.27.
3. ☒ Specification *Total Pages* **44**
4. ☒ Drawing(s) (35 USC 113) *Total Sheets* **3**
5. ☐ Oath or Declaration *Total Pages*
- a. ☐ Newly executed (original or copy)
- b. ☐ Copy from a prior application (37 CFR 1.63(d))
(for continuation/divisional with Box 17 completed)
- i. ☐ DELETION OF INVENTOR(S)
Signed Statement attached deleting
inventor(s) named in the prior application, see
37 CFR 1.63(d)(2) and 1.33(b).
6. ☒ Application Data Sheet. See 37 CFR 1.76

7. ☐ CD-ROM or CD-R in duplicate, large table or Computer
Program (*Appendix*)
8. ☐ Nucleotide and/or Amino Acid Sequence Submission
(if applicable, all necessary)
- a. ☐ Computer Readable Form (CRF)
- b. Specification Sequence Listing on:
- i. ☐ CD-ROM or CD-R (2 copies); or
- ii. ☐ paper
- c. ☐ Statements verifying identity of above copies

ACCOMPANYING APPLICATION PARTS

9. ☐ Assignment Papers (cover sheet & document(s))
10. ☐ 37 CFR 3.73(b) Statement ☐ Power of Attorney
(when there is an assignee)
11. ☐ English Translation Document (if applicable)
12. ☐ Information Disclosure Statement (IDS)/PTO-1449 ☐ Copies of IDS
Citations
13. ☒ Preliminary Amendment
14. ☒ Return Receipt Postcard (MPEP 503)
(Should be specifically itemized)
15. ☐ Certified Copy of Priority Document(s)
(if foreign priority is claimed)
16. ☐ Other: _____

17. If a CONTINUING APPLICATION, check appropriate box and supply the requisite information:

☐ Continuation ☐ Divisional ☐ Continuation-in-part (CIP) of prior application No. ____/_____
Prior application information: Examiner _____ Group/Art Unit: _____

For CONTINUATION OR DIVISIONAL APPS only: The entire disclosure of the prior application, from which an oath or declaration is supplied under Box 5b, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference. The incorporation can only be relied upon when a portion has been inadvertently omitted from the submitted application parts.

18. CORRESPONDENCE ADDRESS☒

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CLAIMS	(1) FOR	(2) NUMBER FILED	(3) NUMBER EXTRA	(4) RATE	(5) CALCULATIONS
	TOTAL CLAIMS (37 CFR 1.16(c))	60-20 =	40	X \$ 18.00 =	\$720.00
	INDEPENDENT CLAIMS (37 CFR 1.16(b))	2-3 =	0	X \$ 80.00 =	\$0
	MULTIPLE DEPENDENT CLAIMS (if applicable) (37 CFR 1.16(d))			\$270.00 =	\$270.00
				BASIC FEE (37 CFR 1.16(a))	\$710.00
			Total of above Calculations =		\$1,700.00
	Reduction by 50% for filing by small entity (Note 37 CFR 1.9, 1.27, 1.28).				
	TOTAL =				\$1,700.00

19. Small entity status

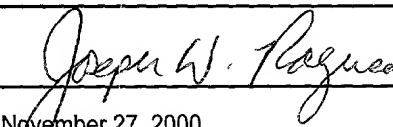
- a. ☐ A small entity statement is enclosed
- b. ☐ A small entity statement was filed in the prior nonprovisional application and such status is still proper and desired.
- c. ☐ Is no longer claimed.

20. ☒ A check in the amount of \$ 1,700.00 to cover the filing fee is enclosed.

21. ☐ A check in the amount of \$ _____ to cover the recordal fee is enclosed.

22. The Commissioner is hereby authorized to credit overpayments or charge the following fees to Deposit Account No. 06-1205:

- a. ☒ Fees required under 37 CFR 1.16.
- b. ☒ Fees required under 37 CFR 1.17.
- c. ☐ Fees required under 37 CFR 1.18.

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT REQUIRED	
NAME	Joseph W. Ragusa, Reg. No. 38,586
SIGNATURE	
DATE	November 27, 2000

INVENTOR INFORMATION

Inventor One Given Name:: Jun
Family Name:: Koide
Postal Address Line One:: 10-2-1203, Shintomi 1-chome
Postal Address Line Two:: Chuo-ku
City:: Tokyo
Country:: Japan
City of Residence:: Tokyo
Country of Residence:: Japan
Citizenship Country:: Japan

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 05514
Fax:: (212) 218-2200

APPLICATION INFORMATION

Title Line One:: LASER WORKING PPARATUS, LASER WORKING METHOD,
Title Line Two:: METHOD FOR PRODUCING INK JET RECORDING HEAD
Title Line Three:: UTILIZING SUCH LASER WORKING APPARATUS OR
Title Line Four:: METHOD, AND INK JET RECORDING HEAD FORMED BY
Title Line Five:: SUCH PRODUCING METHOD
Total Drawing Sheets:: 3
Formal Drawings?: Yes
Application Type:: Utility Patent Application
Docket Number:: 35.C14946
Secrecy Order in Parent Appl.?: No

REPRESENTATIVE INFORMATION

Representative Customer Number:: 5514

PRIOR FOREIGN APPLICATIONS

Foreign Application One:: 11-339342
Filing Date:: November 30, 1999
Country:: Japan
Priority Claimed:: Yes
Foreign Application Two:: 11-339344
Filing Date:: November 30, 1999
Country:: Japan
Priority Claimed:: Yes

35.C14946

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
JUN KOIDE) : Examiner: Not Yet Assigned
Application No.: N/Y/A) : Group Art Unit: N/Y/A
Filed: November 28, 2000) :
For: LASER WORKING)
APPARATUS, LASER) :
WORKING METHOD,) :
METHOD FOR PRODUCING) :
INK JET RECORDING) :
HEAD UTILIZING SUCH) :
LASER WORKING) :
APPARATUS OR METHOD, AND) :
INK JET RECORDING HEAD) :
FORMED BY SUCH PRODUCING) :
METHOD) November 27, 2000

Commissioner for Patents
Washington, D.C. 20231

PRELIMINARY AMENDMENT

Sir:

Prior to examination, please amend the above-
identified application as follows:

In The Claims:

Please amend claim 29 as follows:

29. (Amended) A method for producing an ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge orifice and said liquid chamber, an energy generating element provided in a part of said ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the exterior etc., by working a member constituting at least a part of said ink flow path by a laser working apparatus;

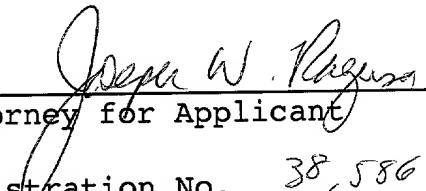
wherein a member constituting at least a part of said ink flow path is sublimatedly worked by using the laser working apparatus according to [either one of claims 1, 2, 4 to 10, or 12 to 24] claim 1 or the laser working method according to [either] any one of claims 25 to 28.

REMARKS

Claim 29 has been amended to place it in proper multiple dependent form. An early and favorable Office Action on the merits is requested.

Applicant's undersigned attorney may be reached in our New York office by telephone at (212) 218-2100. All correspondence should continue to be directed to our below listed address.

Respectfully submitted,



Attorney for Applicant
Registration No. 38,586

FITZPATRICK, CELLA, HARPER & SCINTO
30 Rockefeller Plaza
New York, New York 10112-3801
Facsimile: (212) 218-2200

LASER WORKING APPARATUS, LASER WORKING METHOD, METHOD
FOR PRODUCING INK JET RECORDING HEAD UTILIZING SUCH
LASER WORKING APPARATUS OR METHOD, AND INK JET
RECORDING HEAD FORMED BY SUCH PRODUCING METHOD

5

BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to a laser working
apparatus, a laser working method, a method for
10 producing an ink jet recording head utilizing such
laser working apparatus or method, and an ink jet
recording head produced by such producing method, and
more particularly to a laser working apparatus and a
laser working method capable of ablation working of a
15 work article and of fine working of a complex material
and a complex structure such as of a micromachine, an
IC and a hybrid IC device.

Related Background Art

In case of forming a fine structure directly on a
20 work article by laser light, there is generally
employed a harmonic wave of an excimer laser or a YAG
laser, but, since the energy density of the laser light
in the oscillated pulse is limited to the order of 100
megawatts at maximum, the laser working is difficult in
25 materials of high thermal conductivity such as metals,
ceramics or minerals (such as silicon) or those of low
light absorbance such as quartz or glass, and can only

be applied for the sublimation ablation working principally of organic resinous materials. Because of such drawbacks, in case of fine working of a compound material including or composed of the aforementioned metals, ceramics, minerals or glass, the desired structure can only be formed by a lithographic process requiring steps of resist coating, resist patterning by exposure, resist development, etching utilizing the resist pattern and resist ashing for each of the different materials.

Also in the manufacture of an ink jet recording head which is generally provided, in the ink discharge mechanism, with an ink discharge orifice for discharging ink, a liquid chamber containing ink to be supplied to the ink discharge orifice, an ink flow path connecting the ink discharge orifice and the liquid chamber, an energy generating element provided in a part of the ink flow path for generating energy for ink discharge and an ink supply aperture for ink supply to the liquid chamber from the exterior, it is being tried to form the ink discharge orifice in a compound material including a laminated metal film in order to provide the plate bearing the ink discharge orifice (hereinafter called orifice plate) with a function not achievable with a resinous material only. In such case there is applied press working process or lithographic pattern etching process, but the press working is

limited in the precision and is unsuitable for fine working. Also the etching process is disadvantageous in cost because of the complex working process, and also in the significant investment required for the production facility, in consideration of the process tact time.

As explained in the foregoing, there is generally required a complex working process such as the lithographic process, in order to form a fine structure in the work article.

Therefore, the present applicant already proposed, for example in the Japanese Patent Applications Nos. 2000-187464, 2000-188333 and 2000-187146, means utilizing so-called femtosecond laser described for example in the "Next Generation Optotechnology Review" (published 1992 by Optronics Co.; Part 1 Elementary Technology; Generation and compression of ultra short light pulse, pp.24-31) and executing irradiation with the laser light in plural pulses of a high energy density in space and in time, emitted from a laser oscillator having a pulse emission time not exceeding 1 picosecond, in concentrated manner with a predetermined energy density, thereby achieving sublimation ablation working before the laser light is diffused as thermal energy in the work article. With such means, since the pulse emission time not exceeding 150 femtoseconds and

an optical energy exceeding 500 microjoules per pulse being achievable in the commercially available femtosecond lasers, thus providing an energy density of about 3 gigawatts in the oscillated pulse of the emitted laser light), and since the laser irradiation time is very short, the sublimation ablation working process can be completed before the laser light is diffused as thermal energy in the work article. Such phenomenon may be scientifically interpreted that the optical energy is not converted into thermal energy but directly functions as the lattice cleaving energy because the photons require a time of about 1 picosecond for conversion into phonons or thermal quantum particles by absorption in the electrons.

Such phenomenon allows to concentrate energy even in materials of high thermal conductivity such as metals, ceramics or minerals (for example silicon) thereby easily achieving the working by a multi-photon absorbing process, and the working becomes possible even in materials of low light absorbance such as glass, quartz or optical crystals as long as they have an absorbance of 0.1 to 1%, since, even in such materials, the optical energy density reaches a gigawatt level which is more than 100 times higher than that achievable with the excimer laser.

Consequently the optical ablation working, utilizing the high output femtosecond laser capable of

emitting a high power laser light with a pulse emission time not exceeding 1 picosecond, is highly promising as the fine working process not limited in the material, and is therefore actively developed in recent years.

5 However, the above-mentioned laser oscillation system, capable of emitting the laser light with a pulse emission time not exceeding 1 picosecond, generally employs vertical mode synchronization for oscillation, and the compression of the laser pulse in
10 time is realized by the vertical mode synchronization, which requires adjustment of an optical member in the laser system in the order of a micrometer. For this reason, the system is very sensitive to the thermal expansion or contraction of the members constituting
15 the system, and, if the repeated oscillation state of the laser is changed for example by a burst oscillation or a modulation of the repeated oscillation frequency, the thermal equilibrium in the laser oscillator is perturbed to cause instability of the temperature
20 therein, whereby the support member for the optical members causes thermal expansion or contraction to disrupt the optical adjustment of the micrometer order, thereby resulting in a variation in the oscillated pulse duration and the output energy of the laser
25 light. In order to avoid such drawbacks, the above-mentioned laser oscillation system is operated under temperature control of the order of 0.1°C for the

portions of laser oscillation and amplification, but such temperature control is still insufficient and it is still desirable to operate the system in a continuous pulse oscillation mode in a stationary state.

On the other hand, in case of using such continuous pulse oscillation mode for actual working process, a light intercepting device or a light intensity attenuating device has to be provided in the optical path of the continuously emitted laser light, but such device, if simply provided in the laser oscillator, results in the following drawbacks.

As explained in the foregoing, since the laser emission of the extremely short pulse emission time is achieved by the vertical mode synchronization, the optical members in the laser oscillation system have to be positioned with a precision of the order of a micrometer, and the entire laser oscillator is precisely controlled in temperature with a precision of the order of 0.1°C . If a light intercepting device or a light intensity attenuating device is simply provided in the main body of such laser oscillator, such device absorbs or emits the energy of the laser, whereby the temperature in the laser oscillator is elevated by the absorption of the optical energy and the laser oscillation itself becomes extremely unstable.

Also, for achieving optimum fine working with a

higher precision, it is not sufficient to merely consider the influence on the temperature control of the entire laser oscillating portion, in providing the light intercepting device or the like therein. For achieving optimum fine working with a higher precision by the optical ablation working, the burst irradiation of the laser light in continuous pulses of a constant frequency is not sufficient but it is also required to vary the repeating frequency of the laser light pulses or to vary the ratio in time of the laser irradiating state and the laser non-irradiating state, according to the physical characteristics of the work article, the structure to be formed or the proceeding of working. More specifically it is required to optimize the interval of laser irradiations or to avoid the change in the ablating characteristics resulting from the shielding and absorption of the light by the plasma cloud, according to the scattered state of the plasma, atomic and molecular particles generated by the optical ablation. However, if the oscillation frequency of the laser light pulses from the laser oscillation system constituting the light source is directly modulated, there results the aforementioned drawback that the thermal equilibrium is perturbed to alter the characteristics of the laser light.

In consideration of the foregoing, the object of the present invention is to provide a laser working

apparatus and a laser working method capable of
controlling the irradiation with the laser light
continuously emitted from the laser oscillator without
affecting the temperature control of the entire laser
oscillating portion, thereby achieving desired optical
ablation working, also a producing method for an ink
jet recording head utilizing such laser working
apparatus or method, and an ink jet recording head
obtained by such producing method.

SUMMARY OF THE INVENTION

The above-mentioned object can be attained,
according to the present invention, by a laser working
apparatus, a laser working method, a producing method
for an ink jet recording head utilizing such laser
working apparatus or method, and an ink jet recording
head obtained by such producing method, featured by the
following configurations (1) to (30):

(1) A laser working apparatus for effecting optical
ablation working by irradiating a work article with
laser light from a laser oscillator capable of
continuous emission of a light pulse of a large energy
density in space and in time, with a pulse emission
time not exceeding 1 picosecond;

wherein control means for controlling the
irradiation of the laser light is provided in a
position not affecting the temperature control of the

laser oscillating portion and a configuration is provided for controlling the irradiation of the laser light continuously emitted from the laser oscillator by the control means thereby effecting optical ablation working on the work article.

(2) A laser working apparatus according to (1), wherein the control means is provided outside the laser oscillator or in a chamber separate from a laser oscillation chamber in the laser oscillator.

(3) A laser working apparatus according to (1) or (2), wherein the control means is a light intercepting device capable of transmitting or intercepting the laser light, and a configuration is provided for irradiating the work article with a predetermined number of pulses by the light intercepting device thereby achieving optical ablation working.

(4) A laser working apparatus according to (3), wherein the light intercepting device is arranged by a mechanical electromagnetic chopper.

(5) A laser working apparatus according to (3), wherein the light intercepting device is arranged by an electrical liquid crystal shutter.

(6) A laser working apparatus according to (3), wherein the light intercepting device achieves interception of light by a diffraction effect in an acoustooptical modulator (AOM).

(7) A laser working apparatus according to (3),

wherein the light intercepting device achieves interception of light by a diffraction effect in an electrooptical modulator (EOM).

(8) A laser working apparatus according to (1),
5 wherein the control means is light intensity attenuating means capable of controlling the attenuation of the intensity of the laser light, and a configuration is provided for irradiating the work article with a predetermined energy density by the
10 light intensity attenuating means.

(9) A laser working apparatus according to (8),
wherein the light intensity attenuating means is arranged by a variable light attenuator for controlling the intensity of the transmitting light by varying the
15 incident angle of light.

(10) A laser working apparatus according to (8),
wherein the light intensity attenuating means is arranged by a light absorbing filter.

(11) A laser working apparatus according to (1) or
20 (2), wherein the control means is a light interception control device capable of repeating the transmission and interception of the transmitting light with a frequency smaller (or a period longer) than that of the consecutive light pulses emitted from the laser
25 oscillator, and a configuration is provided for irradiating the work article with the consecutive light pulses at a predetermined interval by the light

interception control device, thereby achieving optical ablation working.

(12) A laser working apparatus according to (11), wherein the light interception control device is
5 arranged by a mechanical rotary chopper.

(13) A laser working apparatus according to (12), wherein the time ratio of transmission and interception of the light by the mechanical rotary chopper is set by the shape of a shielding plate of the mechanical rotary
10 chopper.

(14) A laser working apparatus according to (11), wherein the light interception control device is arranged by an electromagnetically controlled mechanical shutter.

(15) A laser working apparatus according to (11), wherein the light interception control device is arranged by an electrical liquid crystal shutter.
15

(16) A laser working apparatus according to (11), wherein the light interception control device executes
20 interception of the light utilizing the diffraction effect of an acoustooptical modulator (AOM).

(17) A laser working apparatus according to (11), wherein the light interception control device executes interception of the light utilizing the diffraction
25 effect of an electrooptical modulator (EOM).

(18) A laser working apparatus according to (11), wherein the temperature increase of the light

interception control device by the absorption of the laser light is prevented by air cooling means such as an air blower or by liquid cooling means such as a circulating liquid heat exchanger.

5 (19) A laser working apparatus according to (11), wherein the laser light reflected by the light interception control device is absorbed by a light absorbing material such as a carbon block.

(20) A laser working apparatus according to (11),
10 wherein the repeating period of transmission and interception of the light by the light interception control device is controlled by the electrical or mechanical control of the light interception control device by controller means.

15 (21) A laser working apparatus according to (20), wherein the controller means is adapted to variably control the repeating period of transmission and interception of the light of the light interception control device, according to the physical properties of
20 the work article and the shape thereof to be worked, or according to the state of progress of the working.

(22) A laser working apparatus according to (20), wherein the controller means is adapted to variably control the time ratio of transmission and interception
25 of the light of the light interception control device, according to the physical properties of the work article and the shape thereof to be worked, or

according to the state of progress of the working.

(23) A laser working apparatus according to (1), wherein the laser oscillator is provided with a spatial compression device for light propagation.

5 (24) A laser working apparatus according to (23), wherein the spatial compression device for light propagation is arranged by chirping pulse generation means and vertical mode synchronization means utilizing the optical wavelength dispersion characteristics.

10 (25) A laser working method for effecting optical ablation working by irradiating a work article with laser light from a laser oscillator capable of continuous emission of light pulses of a large energy density in space and in time, with a pulse emission
15 time not exceeding 1 picosecond;

wherein the temperature of an area including the laser oscillator is controlled, and control means is provided, outside the temperature control area, on the optical axis of the laser light for controlling the
20 irradiation of the laser light continuously emitted from the laser oscillator thereby effecting optical ablation working on the work article.

(26) A laser working method according to (25), wherein the control means is arranged by a light intercepting
25 device capable of transmitting or intercepting the laser light, and the light intercepting device irradiates the work article with a predetermined number

of pulses thereby achieving optical ablation working.

(27) A laser working method according to (25), wherein the control means is arranged by light intensity attenuating means capable of controlling the
5 attenuation of the intensity of the laser light, and the light intensity attenuating means irradiates the work article with a predetermined energy density thereby achieving optical ablation working.

(28) A laser working method according to (25), wherein
10 the control means is arranged by a light interception control device capable of repeating the transmission and interception of the transmitting light with a frequency smaller (or a period longer) than that of the consecutive light pulses emitted from the laser
15 oscillator, and the light interception control device irradiates the work article with the consecutive light pulses at a predetermined interval, thereby achieving optical ablation working.

(29) A method for producing an ink jet recording head
20 provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to the discharge orifice, an ink flow path connecting the discharge orifice and the liquid chamber, an energy
25 generating element provided in a part of the ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying the liquid

chamber with the ink from the exterior etc., by working a member constituting at least a part of the ink flow path by a laser working apparatus;

wherein a member constituting at least a part of the ink flow path is sublimatedly worked by using the laser working apparatus according to either one of (1) to (24) or the laser working method according to either one of (25) to (28).

(30) An ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to the discharge orifice, an ink flow path connecting the discharge orifice and the liquid chamber, an energy generating element provided in a part of the ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying the liquid chamber with the ink from the exterior etc., in which a member constituting at least a part of the ink flow path is formed by a laser working apparatus;

wherein the ink jet recording head is produced by the producing method according to (29).

The present invention provides a laser working apparatus and a laser working method capable of achieving desired optical ablation working by controlling the irradiation of the laser light continuously emitted from the laser oscillator, without

affecting the temperature control of the entire laser oscillating portion, and a method for producing an ink jet recording head utilizing such laser working apparatus or method and an ink jet recording head
5 produced by such producing method.

Also the present invention provides a laser working apparatus and a laser working method capable of achieving precise laser working of predetermined depth and shape by irradiating the work article with a
10 predetermined number of pulses by controlling the transmission and interception of the laser light, under stable laser oscillation and without affecting the temperature control of the entire laser oscillating portion, and a method for producing an ink jet
15 recording head utilizing such laser working apparatus or method and an ink jet recording head produced by such producing method.

Also the present invention provides a laser working apparatus and a laser working method capable of achieving precise laser working with a smooth worked
20 surface by irradiating the work article with a predetermined energy density by controlling the intensity of the laser light, under stable laser oscillation and without affecting the temperature
25 control of the entire laser oscillating portion, and a method for producing an ink jet recording head utilizing such laser working apparatus or method and an

ink jet recording head produced by such producing method.

Also the present invention provides a laser working apparatus and a laser working method capable of optimizing the interval of laser irradiation in consideration of the scattered state of the plasma and gaseous atoms or molecules generated by the optical ablation and avoiding the variation in the ablating characteristics resulting from the light interception and absorption by the plasma cloud, thereby achieving optimum laser working of high precision by controlling the repeating period of the laser light pulses or the time ratio of laser irradiating state and laser non-irradiating state according to the physical properties and work shape of the work article or the state of progress of working, without affecting the temperature control of the entire laser oscillating portion, and a method for producing an ink jet recording head utilizing such laser working apparatus or method and an ink jet recording head produced by such producing method.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a schematic view showing the optical configuration of a laser working apparatus constituting an example 1 of the present invention;

Fig. 2 is a schematic view showing the optical

configuration of a laser working apparatus constituting an example 2 of the present invention;

Fig. 3 is a schematic view showing the optical configuration of a laser working apparatus constituting
5 an example 3 of the present invention;

Fig. 4 is a schematic view of a rotary chopper in the example 3 of the present invention;

Fig. 5 is a view showing the sequence of laser irradiating method of the example 3 of the present
10 invention; and

Figs. 6A, 6B and 6C are schematic views showing an ink jet recording head produced by a producing method embodying the present invention.

15 DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

In a first embodiment of the present invention, the control means for controlling the laser light irradiation is arranged by a light intercepting device, which is provided in a position not affecting the
20 temperature control of the aforementioned laser oscillating portion, whereby the transmission and interception of the laser light, continuously emitted from the laser oscillator, can be controlled without generating heat from the optical energy in the laser
25 oscillating portion. It is thus rendered possible to control the transmission and interception of the light under stable laser oscillation, without affecting the

temperature control of the entire laser oscillating portion, and to irradiate the work article with a predetermined number of pulses thereby achieving precise laser working of a predetermined depth.

5 In a second embodiment of the present invention, the control means for controlling the laser light irradiation is arranged by light intensity attenuating means, which is provided in a position not affecting the temperature control of the aforementioned laser
10 oscillating portion, whereby the intensity of the laser light, continuously emitted from the laser oscillator, can be attenuated without generating heat from the optical energy in the laser oscillating portion. It is thus rendered possible to attenuate the intensity of
15 the light under stable laser oscillation, without affecting the temperature control of the entire laser oscillating portion, and to irradiate the work article with a predetermined energy density thereby achieving precise laser working with a smooth worked surface.

20 In a third embodiment of the present invention, a light interception control device capable of controlling the repetition of transmission and interception of the transmitting light at a frequency smaller than that of the consecutive light pulses
25 emitted from the laser oscillator is provided in a position not affecting the temperature control of the aforementioned laser oscillating portion, whereby the

repeating period of the laser light pulses or the time ratio of the laser irradiating state and laser non-irradiating state can be controlled according to the physical properties and work shape of the work article
5 or the state of progress of the working, without affecting the temperature control of the entire laser oscillating portion, thereby achieving highly precise optimum fine laser working. A direct modulation of the oscillation frequency of the laser light pulses in the
10 laser oscillation system, constituting the light source, will result in a change in the characteristics of the laser light, resulting from a perturbation in the thermal equilibrium state. However, a similar effect can be obtained in pseudo manner by varying the
15 repeating period of the transmission and interception of light in the light interception control device or by varying the time ratio of the transmission and interception of the light in the light interception control device, as explained in the foregoing.

20 In the following, examples of the present invention will be explained with reference to the accompanying drawings. The examples 1, 2 and 3 respectively correspond to the aforementioned first, second and third embodiments.

25 [Example 1]

Fig. 1 is a schematic view showing the optical path of the optical system of a laser working apparatus

in the example 1 of the present invention.

There are shown a short pulse laser oscillator 101, a mask illuminating optical system 104 including a field lens, a condenser lens etc. (including other
5 illuminating methods such as Koehler illuminating system and critical illuminating system), a photomask 105, a projection imaging lens 107, and a work article 108.

In the above-mentioned optical system, a laser
10 light beam 102 emitted from the short pulse laser oscillator 101 in a direction indicated by an arrow illuminates the photomask 105 by means of the mask illuminating optical system 104 including a field lens, a condenser lens etc. (including other illuminating
15 methods such as Koehler illuminating system, critical illuminating system etc.). A laser light beam 106 transmitted by a mask pattern formed on the photomask 105 is focused and projected by the projection imaging lens 107, onto the work article 108, which is thus
20 worked by the laser oscillation.

The laser oscillator emitting the laser light with a pulse oscillation time not exceeding 1 picosecond, adapted for use in such laser working apparatus, is a laser oscillator utilizing the vertical mode
25 synchronization. The laser pulses from such laser oscillator are generally emitted in consecutive manner. Therefore, in order to control the irradiation to a

predetermined number of pulses, the present example employs a light intercepting device 103 capable of controlling the transmission and interception of light, positioned in the optical path of the laser light beam 102 emitted from the laser oscillator 101 but in a position not affecting the temperature control of the entire laser oscillating portion such as outside the laser oscillator or in a chamber separate from a laser oscillating chamber in the laser oscillator, and the work article is worked by a predetermined amount by on/off control wherein the light transmitting state and the light non-transmitting state are respectively taken as "on" and "off". The aforementioned position not affecting the temperature control of the entire laser oscillating portion is preferably between the laser oscillator 101 and the optical system in the optical path of the aforementioned optical system, and more preferably in the vicinity of the laser light exit of the laser oscillator 101.

The timing of shuttering operation of such device may be controlled by counting the number of pulses or the time.

The present example employs an electromagnetic mechanical shutter of chopper type as the light intercepting device mentioned above.

However, in order to realize a short operation time that is not achievable with such mechanical

shutter, it is also possible to turn on and off the light interception for example by an electrically controlled liquid crystal shutter, or an acoustooptical modulator (AOM) element or an electrooptical modulator (EOM) element for changing the proceeding direction of light between an "on" state in which the light proceeds straight and an "off" state in which the light is deflected by the optical diffraction effect. However, the laser pulse not exceeding 1 picosecond, generally oscillated by multiple vertical mode, is associated with a spread laser wavelength head. For this reason, there is encountered a drawback that the laser pulse width is somewhat elongated upon passing a bulk optical element because of the wavelength dispersion characteristics thereof.

Also in case of multiple work articles, namely in case of application to mass production, the stability of the pulse duration and the output energy, which are the oscillation characteristics of the laser, are very important. It therefore becomes essential, as in the present example, to turn on and off the laser irradiation by positioning the light intercepting device in a part of the optical path not affecting the temperature control of the laser oscillating portion.

[Example 2]

Fig. 2 is a schematic view showing the optical path of the optical system of a laser working apparatus

in the example 2 of the present invention.

There are shown a short pulse laser oscillator 201, a mask illuminating optical system 204 including a field lens, a condenser lens etc. (including other
5 illuminating methods such as Koehler illuminating system and critical illuminating system), a photomask 205, a projection imaging lens 207, and a work article 208.

In the above-mentioned optical system, a laser
10 light beam 202 emitted from the short pulse laser oscillator 201 in a direction indicated by an arrow illuminates the photomask 205 by means of the mask illuminating optical system 204 including a field lens, a condenser lens etc. (including other illuminating
15 methods such as Koehler illuminating system, critical illuminating system etc.). A laser light beam 206 transmitted by a mask pattern formed on the photomask 205 is focused and projected, by the projection imaging lens 207, onto the work article 208, which is thus
20 worked by the laser oscillation.

The laser oscillator emitting the laser light with a pulse oscillation time not exceeding 1 picosecond, adapted for use in such laser working apparatus, is a laser oscillator utilizing the vertical mode
25 synchronization. The laser pulse energy from such laser oscillator is generally constant. Therefore, in order to control the irradiation to a predetermined

light intensity, the present example employs light intensity attenuating means 203 in the optical path of the laser light beam 202 emitted from the laser oscillator 201 but in a position not affecting the temperature control of the entire laser oscillating portion such as outside the laser oscillator or in a chamber separate from a laser oscillating chamber in the laser oscillator, and the work article is worked in optimum manner by the control of the irradiating light intensity at the optimum level. The aforementioned position not affecting the temperature control of the entire laser oscillating portion is preferably between the laser oscillator 201 and the optical system in the optical path of the aforementioned optical system, and more preferably in the vicinity of the laser light exit of the laser oscillator 201.

In the present example, the light intensity attenuating means is arranged by a variable attenuator. Naturally it may also be arranged by a light absorbing filter or a simple optical attenuator.

However, the laser pulse not exceeding 1 picosecond, generally oscillated by multiple vertical mode, is associated with a spread laser wavelength band. For this reason, there is encountered a drawback that the laser pulse width is somewhat elongated upon passing a bulk optical element because of the wavelength dispersion characteristics thereof.

Also in case of multiple work articles, namely in case of application to mass production, the stability of the pulse duration and the output energy, which are the oscillation characteristics of the laser, are very important. It therefore becomes essential, as in the present example, to position the light intensity attenuating means in a part of the optical path not affecting the temperature control of the laser oscillating portion.

10 [Example 3]

Fig. 3 is a schematic view showing the optical path of the optical system of a laser working apparatus in the example 3 of the present invention.

Referring to Fig. 3, a laser light beam 302 emitted from a short pulse laser oscillator 301 in a direction indicated by an arrow illuminates a photomask 305 by means of a mask illuminating optical system 304 including a field lens, a condenser lens etc. (including other illuminating methods such as Koehler illuminating system, critical illuminating system etc.). A laser light beam 306 transmitted by a mask pattern formed on the photomask 305 is focused and projected, by a projection imaging lens 307, onto a work article 108, which is thus worked by the laser oscillation.

The laser oscillator emitting the laser light with a pulse oscillation time not exceeding 1 picosecond,

adapted for use in such laser working apparatus,
executes compression of the optical pulse time,
utilizing the vertical mode synchronization, and the
pulses are emitted in continuous manner with a fixed
5 period as explained in the foregoing, with an
oscillation frequency of about 1 kHz in the
commercially available laser oscillators. Therefore,
in the present example, a light interception control
device is arranged by a rotary chopper 304 positioned
10 in the optical path of the laser light beam 302 emitted
from the laser oscillator 301, and a rotary disk shaped
as a windmill as shown in Fig. 4 is rotated in a
direction indicated by an arrow under the control of
the rotating speed by unrepresented motor and
15 controller, thereby controlling the cycle time of
transmission and interception of the laser light from
several Hertz to a value slightly less than the
oscillation frequency of the laser oscillator. The
time ratio of light transmission and interception is
20 determined by the windmill shape of the chopper.

Portions of the rotary chopper 303 constituting
the light interception control device, receiving the
irradiation by the laser light, are coated in a color
showing a high absorbance to the wavelength of the
25 laser light, whereby, when in the light-intercepting
state, the laser light is absorbed by the chopper
member and converted into thermal energy. Since the

laser beam is spread spatially, the irradiation energy density of the laser light does not reach the ablating threshold, whereby the optical energy does not cause ablation working but is merely converted into thermal energy, so that the chopper is not damaged. Also the heated rotary chopper 303 is cooled by blowing air or nitrogen gas from a gas blower 309.

In case the laser light is partially reflected in the light-intercepting state, certain measures have to be provided for dealing with such reflected light, though such measures are not illustrated. The reflected light is finally absorbed by a light absorbing material such as carbon.

Also in case the light-intercepting state is realized by deflecting the light by reflection, the deflecting reflective plate has to be inclined from a state perpendicular to the optical axis of the laser light in order that the reflected light does not return to the laser oscillator, and the reflected light has to be finally absorbed by a light absorbing material such as carbon.

In terminating the optical ablation working, the rotary chopper 303 constituting the light interception control device can be stopped in the light-intercepting state.

In the present example, the light interception control device is arranged by a repeating mechanical

shutter such as the rotary chopper, but it may also be arranged by an electromagnetically controlled mechanical shutter, or, in order to realize a short operation time that is not achievable with such

5 mechanical shutter, it is also possible to turn on and off the light interception for example by an electrically controlled liquid crystal shutter, or an acoustooptical modulator (AOM) element or an electrooptical modulator (EOM) element for changing the

10 proceeding direction of light between an "on" state in which the light proceeds straight and an "off" state in which the light is deflected by the optical diffraction effect. In such case, the cycle time of light transmission and interception, and the time ratio of

15 transmission and interception of the laser light can be controlled by controller means for the shutter.

However, the laser pulse not exceeding 1 picosecond, generally oscillated by multiple vertical mode, is associated with a spread laser wavelength

20 band. For this reason, there is encountered a drawback that the laser pulse width is somewhat elongated upon passing a bulk optical element, because of the wavelength dispersion characteristics thereof. It is therefore necessary to incorporate correction means,

25 for example utilizing the abnormal wavelength dispersion characteristics, in the optical system.

Also in case of multiple work articles, namely in

case of application to mass production, the stability of the pulse duration and the output energy, which are the oscillation characteristics of the laser, are very important. It therefore becomes essential, as in the present example, to position the light interception control device in a part of the optical path not affecting the temperature control of the laser oscillating portion, thereby controlling the time ratio of transmission and interception of the laser light.

10 The light interception control device may be provided in any position in the optical path of the aforementioned optical system, but is preferably provided in a position where the laser beam becomes a parallel beam, between the laser oscillator 301 and the

15 aforementioned optical system.

The laser working process basically assumes a sequence as shown in Fig. 5, in which an irradiating state X and a non-irradiating state Y are repeated by a train of laser pulses. There is however provided a

20 configuration for achieving precise and optimum optical ablation working by modulating the repeating period of the laser light pulses or modulating the time ratio of the irradiating state and non-irradiating state of the laser light pulses according to the physical properties

25 and work shape of the work article and the state of progress of working.

Figs. 6A, 6B and 6C show an ink jet recording

head, worked by the laser working apparatus of the examples 1 to 3.

Referring to Figs. 6A to 6C, a substrate 33 bears an ink discharge pressure generating element 34 for discharging ink, such as an electrothermal converting element or an electromechanical converting element. The ink discharge pressure generating element 34 is provided in an ink flow path 31 communicating with a discharge orifice 21, and the ink flow paths 31 communicate with a common liquid chamber 32, connected to an ink supply pipe (not shown) for ink supply from an ink tank.

A top plate 35 is provided with recesses for forming the ink flow path 31 and the common liquid chamber 32, and is adjoined to the substrate 33 for forming the ink flow path 31 and the common liquid chamber 32.

On the adjoined body of the substrate 33 and the top plate 35, at an end of the ink flow paths, there is provided an orifice plate 2 having a discharge orifice 21.

Such ink jet recording head can be prepared in the following manner.

At first the substrate 33 is prepared by patterning a heater 34, constituting the heat generating resistor element for generating the ink discharge pressure, an integrated circuit such as shift

registers, and electric wirings on a silicon substrate. Also the top plate 35 is prepared by forming recesses for constituting the ink flow path 31 and the common liquid chamber 32 and an ink supply aperture (not
5 shown) by patterned projection of light pulses of predetermined numbers from the aforementioned laser working apparatus.

Then the substrate 33 and the top plate 35 are mutually aligned and adjoined in such a manner that the
10 end faces at the ink discharge side as well as the ink flow paths 31 and the heaters 34 mutually match. Then the orifice plate 2 in which the orifices are not yet formed is adjoined to the end face, at the ink discharge side, of the adjoined body of the top plate
15 and the substrate, and, in such state, the orifices 21 are formed by patterned irradiation with the light pulses of predetermined numbers by the aforementioned laser working apparatus. Thereafter the ink jet recording head is completed by connecting an electric
20 circuit board on which heater driving terminals are patterned, adjoining an aluminum base plate to the substrate 33, and connecting a holder for holding various members and an ink tank for ink supply.

WHAT IS CLAIMED IS:

1. A laser working apparatus for effecting
optical ablation working by irradiating a work article
with laser light from a laser oscillator capable of
5 continuous emission of a light pulse of a large energy
density in space and in time, with a pulse emission
time not exceeding 1 picosecond;

wherein control means for controlling the
irradiation of said laser light is provided in a
10 position not affecting the temperature control of said
laser oscillating portion and a configuration is
provided for controlling the irradiation of the laser
light continuously emitted from said laser oscillator
by said control means thereby effecting optical
15 ablation working on the work article.

2. A laser working apparatus according to claim
1, wherein said control means is provided outside the
laser oscillator or in a chamber separate from a laser
20 oscillation chamber in the laser oscillator.

3. A laser working apparatus according to claim 1
or 2, wherein said control means is a light
intercepting device capable of transmitting or
25 intercepting said laser light, and a configuration is
provided for irradiating the work article with a
predetermined number of pulses by said light

intercepting device thereby effecting optical ablation working.

4. A laser working apparatus according to claim
5 3, wherein said light intercepting device is arranged
by an electromagnetic mechanical chopper.

5. A laser working apparatus according to claim
3, wherein said light intercepting device is arranged
10 by an electrical liquid crystal shutter.

6. A laser working apparatus according to claim
3, wherein said light intercepting device achieves
interception of light by a diffraction effect in an
15 acoustooptical modulator (AOM).

7. A laser working apparatus according to claim
3, wherein said light intercepting device achieves
interception of light by a diffraction effect in an
20 electrooptical modulator (EOM).

8. A laser working apparatus according to claim
1, wherein said control means is light intensity
attenuating means capable of controlling the
25 attenuation of the intensity of said laser light, and a
configuration is provided for irradiating the work
article with a predetermined energy density by said

light intensity attenuating means, thereby effecting light ablation working.

9. A laser working apparatus according to claim
5 8, wherein said light intensity attenuating means is arranged by a variable light attenuator for controlling the intensity of the transmitting light by varying the incident angle of light.

10 10. A laser working apparatus according to claim 8, wherein said light intensity attenuating means is arranged by a light absorbing filter.

11. A laser working apparatus according to claim
15 1 or 2, wherein said control means is arranged by a light interception control device capable of repeating the transmission and interception of the transmitting light with a frequency smaller (or a period longer) than that of the consecutive light pulses emitted from
20 said laser oscillator, and a configuration is provided for irradiating the work article with the consecutive light pulses at a predetermined interval by said light interception control device, thereby effecting optical ablation working.

25

12. A laser working apparatus according to claim 11, wherein said light interception control device is

arranged by a mechanical rotary chopper.

13. A laser working apparatus according to claim
12, wherein the time ratio of transmission and
5 interception of the light by said mechanical rotary
chopper is set by the shape of a shielding plate of
said mechanical rotary chopper.

14. A laser working apparatus according to claim
10 11, wherein said light interception control device is
arranged by an electromagnetically controlled
mechanical shutter.

15. A laser working apparatus according to claim
15 11, wherein said light interception control device is
arranged by an electrical liquid crystal shutter.

16. A laser working apparatus according to claim
11, wherein said light interception control device
20 executes interception of the light utilizing the
diffraction effect of an acoustooptical modulator
(AOM).

17. A laser working apparatus according to claim
25 11, wherein said light interception control device
executes interception of the light utilizing the
diffraction effect of an electrooptical modulator

(EOM).

18. A laser working apparatus according to claim
11, wherein the temperature increase of said light
5 interception control device by the absorption of the
laser light is prevented by air cooling means such as
an air blower or by liquid cooling means such as a
circulating liquid heat exchanger.

10 19. A laser working apparatus according to claim
11, wherein the laser light reflected by said light
interception control device is absorbed by a light
absorbing material such as a carbon block.

15 20. A laser working apparatus according to claim
11, wherein the repeating period of transmission and
interception of the light by said light interception
control device is controlled by the electrical or
mechanical control of said light interception control
20 device by controller means.

21. A laser working apparatus according to claim
20, wherein said controller means is adapted to
variably control the repeating period of transmission
25 and interception of the light of said light
interception control device, according to the physical
properties of the work article and the shape thereof to

be worked, or according to the state of progress of the working.

22. A laser working apparatus according to claim
5 20, wherein said controller means is adapted to
variably control the time ratio of transmission and
interception of the light of said light interception
control device, according to the physical properties of
the work article and the shape thereof to be worked, or
10 according to the state of progress of the working.

23. A laser working apparatus according to claim
1, wherein said laser oscillator is provided with a
spatial compression device for light propagation.
15

24. A laser working apparatus according to claim
23, wherein said spatial compression device for light
propagation is arranged by chirping pulse generation
means and vertical mode synchronization means utilizing
20 the optical wavelength dispersion characteristics.

25. A laser working method for effecting optical
ablation working by irradiating a work article with
laser light from a laser oscillator capable of
25 continuous emission of light pulses of a large energy
density in space and in time, with a pulse emission
time not exceeding 1 picosecond;

wherein control means for controlling the temperature of an area including said laser oscillator is provided outside the temperature control area, on the optical axis of the laser light, for controlling the irradiation of the laser light continuously emitted from said laser oscillator thereby effecting optical ablation working on said work article.

26. A laser working method according to claim 25, wherein said control means is arranged by a light intercepting device capable of transmitting or intercepting the laser light, and said light intercepting device irradiates the work article with a predetermined number of pulses thereby effecting optical ablation working.

27. A laser working method according to claim 25, wherein said control means is arranged by light intensity attenuating means capable of controlling the attenuation of the intensity of said laser light, and said light intensity attenuating means irradiates said work article with a predetermined energy density thereby effecting optical ablation working.

28. A laser working method according to claim 25, wherein said control means is arranged by a light interception control device capable of repeating the

transmission and interception of the transmitting light with a frequency smaller (or a period longer) than that of the consecutive light pulses emitted from said laser oscillator, and said light interception control device
5 irradiates said work article with the consecutive light pulses at a predetermined interval, thereby effecting optical ablation working.

29. A method for producing an ink jet recording
10 head provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge orifice and said liquid
15 chamber, an energy generating element provided in a part of said ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the exterior etc., by working a member constituting at
20 least a part of said ink flow path by a laser working apparatus;

wherein a member constituting at least a part of said ink flow path is sublimatedly worked by using the laser working apparatus according to either one of
25 claims 1, 2, 4 to 10, or 12 to 24 or the laser working method according to either one of claims 25 to 28.

30. A method for producing an ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge orifice and said liquid chamber, an energy generating element provided in a part of said ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the exterior etc., by working a member constituting at least a part of said ink flow path by a laser working apparatus;

wherein a member constituting at least a part of said ink flow path is sublimatedly worked by using the laser working apparatus according to claim 3.

31. A method for producing an ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge orifice and said liquid chamber, an energy generating element provided in a part of said ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the

exterior etc., by working a member constituting at least a part of said ink flow path by a laser working apparatus;

5 wherein a member constituting at least a part of said ink flow path is sublimatedly worked by using the laser working apparatus according to claim 11.

32. An ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to
10 be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge orifice and said liquid chamber, an energy generating element provided in a part of said ink flow path and
15 adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the exterior etc., in which a member constituting at least a part of said ink flow path is formed by a laser working apparatus;

20 wherein the ink jet recording head is produced by the producing method according to claim 29.

33. An ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to
25 be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge

orifice and said liquid chamber, an energy generating element provided in a part of said ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the exterior etc., in which a member constituting at least a part of said ink flow path is formed by a laser working apparatus;

wherein the ink jet recording head is produced by the producing method according to claim 30.

10

34. An ink jet recording head provided with an ink discharge orifice for discharging an ink droplet to be deposited on a recording medium, a liquid chamber for storing ink to be supplied to said discharge orifice, an ink flow path connecting said discharge orifice and said liquid chamber, an energy generating element provided in a part of said ink flow path and adapted to generate energy for discharging ink, an ink supply aperture for supplying said liquid chamber with the ink from the exterior etc., in which a member constituting at least a part of said ink flow path is formed by a laser working apparatus;

15
20

wherein the ink jet recording head is produced by the producing method according to claim 31.

25

ABSTRACT OF THE DISCLOSURE

The invention provides a laser working apparatus for effecting optical ablation working by irradiating a work article with laser light from a laser oscillator capable of continuous emission of light pulses of a large energy density in space and in time, with a pulse emission time not exceeding 1 picosecond, wherein control means for controlling the irradiation of the laser light is provided in a position not affecting the temperature control of the laser oscillating portion and a configuration is provided for controlling the irradiation of the laser light continuously emitted from the laser oscillator by the control means thereby effecting optical ablation working on the work article.

FIG. 1

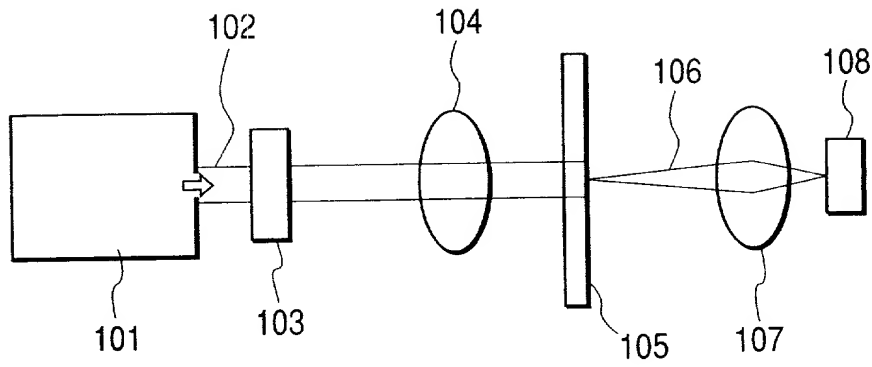


FIG. 2

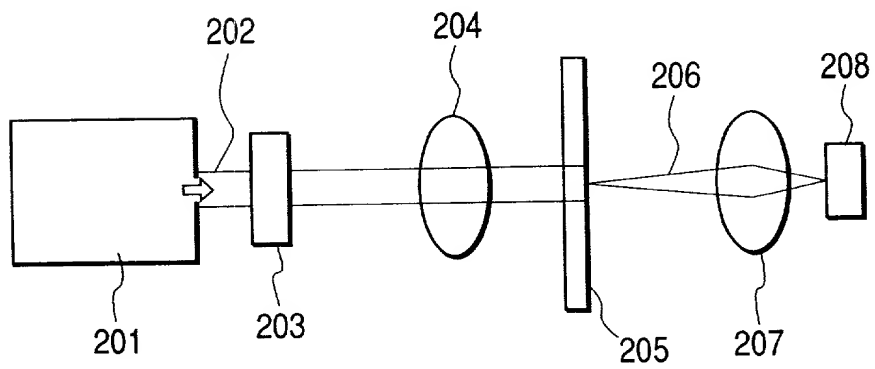


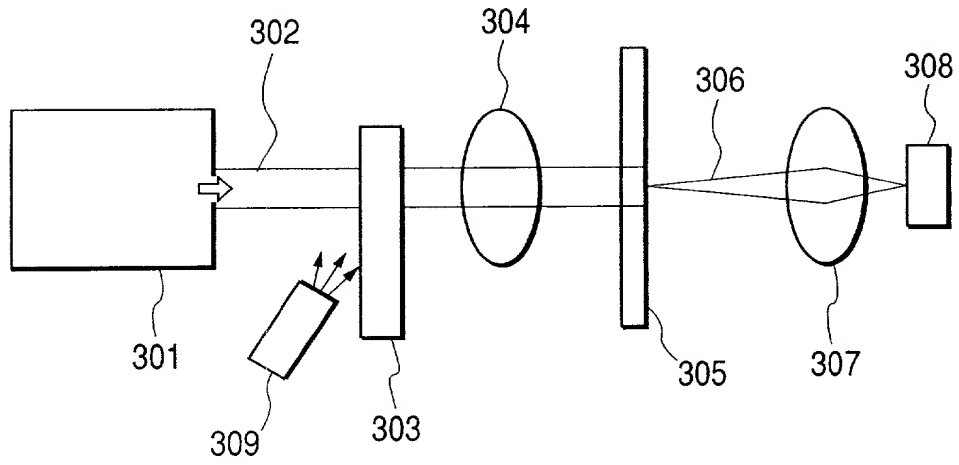
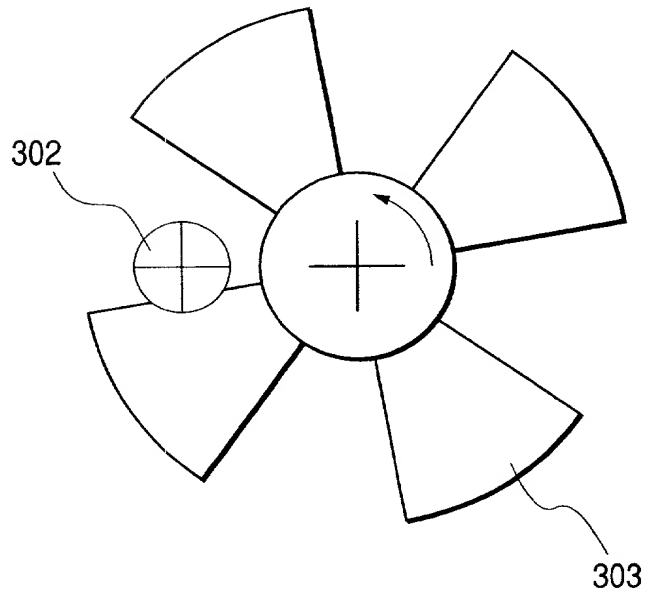
FIG. 3*FIG. 4*

FIG. 5

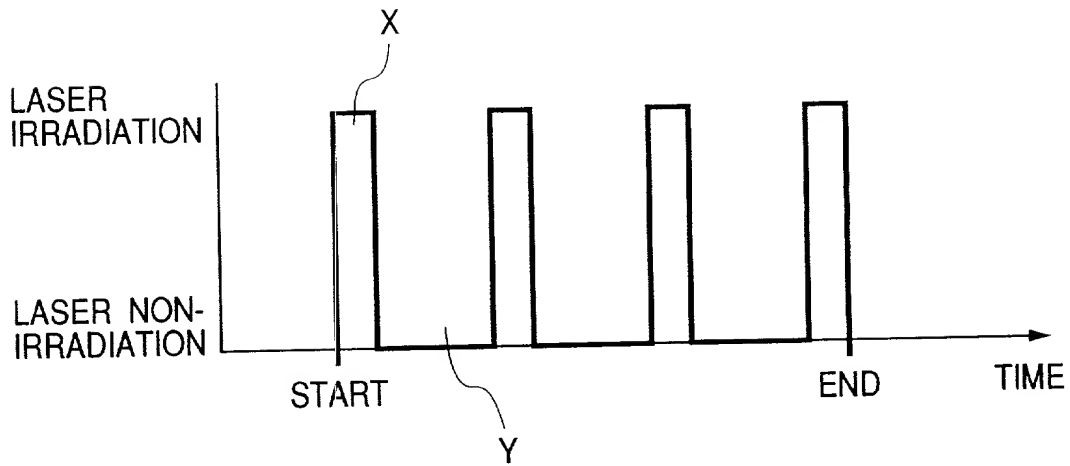


FIG. 6A

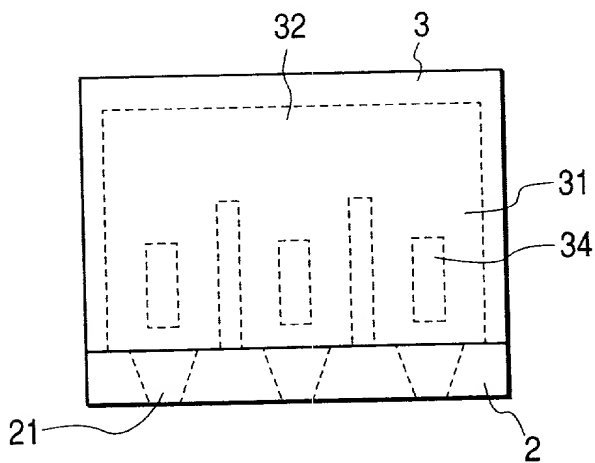


FIG. 6B

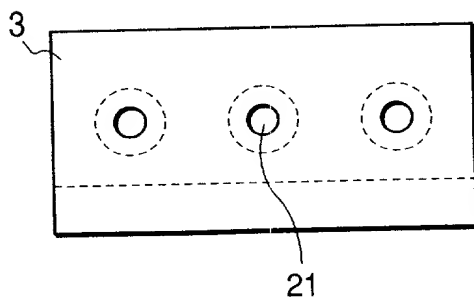


FIG. 6C

